



NEXCOM International Co., Ltd.

IoT Automation Solutions Business Group

Fan-less Computer

NISE 107

User Manual

CONTENTS

Preface

Copyright	iv
Disclaimer	iv
Acknowledgements	iv
Regulatory Compliance Statements	iv
Declaration of Conformity	iv
RoHS Compliance	v
Warranty and RMA	vi
Safety Information	viii
Installation Recommendations	viii
Safety Precautions	ix
Technical Support and Assistance	x
Conventions Used in this Manual	x
Global Service Contact Information	xi
Package Contents	xiii
Ordering Information	xiv

Chapter 1: Product Introduction

NISE 107/NISE 107-E3940 Overview	1
Key Features	1
NISE 107-POE Overview	2
Key Features	2
Hardware Specifications	3
Knowing Your NISE 107 Series	5
Front Panel	5

Rear Panel	6
Mechanical Dimensions	7

Chapter 2: Jumpers and Connectors

Before You Begin	9
Precautions	9
Jumper Settings	10
Locations of the Jumpers and Connectors for NISB 107	11
NISB 107	11
Jumpers and DIP Switches	13
AT/ATX Power Select	13
RTC RTEST Switch (RTC Clear)	13
Connector Pin Definitions	14
External I/O Interfaces - Front Panel	14
Power Button	14
LED Indicators	14
LED Indicators	14
COM 2 Port	15
COM 1 Port	15
External I/O Interfaces - Rear Panel	16
9V - 30V DC Power Input	16
LAN1 Port	16
LAN2 Port	17
USB 3.0 Ports	17
USB 3.0 Ports	18
DisplayPort	18

DVI-D Connector.....	19
Internal Connectors.....	20
FW BIOS Connector.....	20
USB 2.0 Connector.....	20
Port 80 Connector.....	21
COM Port 3 Connector.....	21
COM Port 4 Connector.....	22
GPS Connector.....	22
SATA Connector.....	23
SATA Power Connector.....	23
Remote Button/S3 Connector.....	24
RTC Connector.....	24
GPIO Connector.....	25
Mic-in Connector.....	25
Line-out Connector.....	26
Line-in Connector.....	26
PoE Connector.....	27
Mini-PCIe Connector.....	28
M.2 Connector.....	29

Chapter 3: System Setup

Removing the Chassis Cover.....	30
Installing a SO-DIMM Memory Module.....	32
Installing a Wireless LAN Module (Half-size).....	33
Installing a SIM Card.....	35
Installing a SATA Storage Drive.....	37
Installing an M.2 Card.....	39

Chapter 4: BIOS Setup

About BIOS Setup.....	42
When to Configure the BIOS.....	42
Default Configuration.....	43

Entering Setup.....	43
Legends.....	43
BIOS Setup Utility.....	45
Main.....	45
Advanced.....	46
Chipset.....	54
Security.....	57
Boot.....	58
Save & Exit.....	59

PREFACE

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Disclaimer

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Acknowledgements

NISE 107 is a trademark of NEXCOM International Co., Ltd. All other product names mentioned herein are registered trademarks of their respective owners.

Regulatory Compliance Statements

This section provides the FCC compliance statement for Class A devices and describes how to keep the system CE compliant.

Declaration of Conformity

FCC

This equipment has been tested and verified to comply with the limits for a Class A digital device, pursuant to Part 15 of FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. Operation of this equipment in a residential area (domestic environment) is likely to cause harmful interference, in which case the user will be required to correct the interference (take adequate measures) at their own expense.

CE

The product(s) described in this manual complies with all applicable European Union (CE) directives if it has a CE marking. For computer systems to remain CE compliant, only CE-compliant parts may be used. Maintaining CE compliance also requires proper cable and cabling techniques.

RoHS Compliance



NEXCOM RoHS Environmental Policy and Status Update

NEXCOM is a global citizen for building the digital infrastructure. We are committed to providing green products and services, which are compliant with European Union RoHS (Restriction on Use of Hazardous Substance in Electronic Equipment) directive 2011/65/EU, to be your trusted green partner and to protect our environment.

RoHS restricts the use of Lead (Pb) < 0.1% or 1,000ppm, Mercury (Hg) < 0.1% or 1,000ppm, Cadmium (Cd) < 0.01% or 100ppm, Hexavalent Chromium (Cr6+) < 0.1% or 1,000ppm, Polybrominated biphenyls (PBB) < 0.1% or 1,000ppm, and Polybrominated diphenyl Ethers (PBDE) < 0.1% or 1,000ppm.

In order to meet the RoHS compliant directives, NEXCOM has established an engineering and manufacturing task force to implement the introduction of green products. The task force will ensure that we follow the standard NEXCOM development procedure and that all the new RoHS components and new manufacturing processes maintain the highest industry quality levels for which NEXCOM are renowned.

The model selection criteria will be based on market demand. Vendors and suppliers will ensure that all designed components will be RoHS compliant.

How to recognize NEXCOM RoHS Products?

For existing products where there are non-RoHS and RoHS versions, the suffix "(LF)" will be added to the compliant product name.

All new product models launched after January 2013 will be RoHS compliant. They will use the usual NEXCOM naming convention.

Warranty and RMA

NEXCOM Warranty Period

NEXCOM manufactures products that are new or equivalent to new in accordance with industry standard. NEXCOM warrants that products will be free from defect in material and workmanship for 2 years, beginning on the date of invoice by NEXCOM. HCP series products (Blade Server) which are manufactured by NEXCOM are covered by a three year warranty period.

NEXCOM Return Merchandise Authorization (RMA)

- Customers shall enclose the “NEXCOM RMA Service Form” with the returned packages.
- Customers must collect all the information about the problems encountered and note anything abnormal or, print out any on-screen messages, and describe the problems on the “NEXCOM RMA Service Form” for the RMA number apply process.
- Customers can send back the faulty products with or without accessories (manuals, cable, etc.) and any components from the card, such as CPU and RAM. If the components were suspected as part of the problems, please note clearly which components are included. Otherwise, NEXCOM is not responsible for the devices/parts.
- Customers are responsible for the safe packaging of defective products, making sure it is durable enough to be resistant against further damage and deterioration during transportation. In case of damages occurred during transportation, the repair is treated as “Out of Warranty.”
- Any products returned by NEXCOM to other locations besides the customers’ site will bear an extra charge and will be billed to the customer.

Repair Service Charges for Out-of-Warranty Products

NEXCOM will charge for out-of-warranty products in two categories, one is basic diagnostic fee and another is component (product) fee.

Repair Service Charges for Out-of-Warranty Products

NEXCOM will charge for out-of-warranty products in two categories, one is basic diagnostic fee and another is component (product) fee.

System Level

- Component fee: NEXCOM will only charge for main components such as SMD chip, BGA chip, etc. Passive components will be repaired for free, ex: resistor, capacitor.
- Items will be replaced with NEXCOM products if the original one cannot be repaired. Ex: motherboard, power supply, etc.
- Replace with 3rd party products if needed.
- If RMA goods can not be repaired, NEXCOM will return it to the customer without any charge.

Board Level

- Component fee: NEXCOM will only charge for main components, such as SMD chip, BGA chip, etc. Passive components will be repaired for free, ex: resistors, capacitors.
- If RMA goods can not be repaired, NEXCOM will return it to the customer without any charge.

Warnings

Read and adhere to all warnings, cautions, and notices in this guide and the documentation supplied with the chassis, power supply, and accessory modules. If the instructions for the chassis and power supply are inconsistent with these instructions or the instructions for accessory modules, contact the supplier to find out how you can ensure that your computer meets safety and regulatory requirements.

Cautions

Electrostatic discharge (ESD) can damage system components. Do the described procedures only at an ESD workstation. If no such station is available, you can provide some ESD protection by wearing an antistatic wrist strap and attaching it to a metal part of the computer chassis.

Safety Information

Before installing and using the device, note the following precautions:

- Read all instructions carefully.
- Do not place the unit on an unstable surface, cart, or stand.
- Follow all warnings and cautions in this manual.
- When replacing parts, ensure that your service technician uses parts specified by the manufacturer.
- Avoid using the system near water, in direct sunlight, or near a heating device.
- The load of the system unit does not solely rely for support from the rackmounts located on the sides. Firm support from the bottom is highly necessary in order to provide balance stability.
- The computer is provided with a battery-powered real-time clock circuit. There is a danger of explosion if battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Discard used batteries according to the manufacturer's instructions.



Danger of explosion if battery is incorrectly replaced. Replace with the same or equivalent type recommended by the manufacturer. Discard used batteries according to the manufacturer's instructions.

Installation Recommendations

Ensure you have a stable, clean working environment. Dust and dirt can get into components and cause a malfunction. Use containers to keep small components separated.

Adequate lighting and proper tools can prevent you from accidentally damaging the internal components. Most of the procedures that follow require only a few simple tools, including the following:

- A Philips screwdriver
- A flat-tipped screwdriver
- A grounding strap
- An anti-static pad

Using your fingers can disconnect most of the connections. It is recommended that you do not use needle-nose pliers to disconnect connections as these can damage the soft metal or plastic parts of the connectors.

Safety Precautions

1. Read these safety instructions carefully.
2. Keep this User Manual for later reference.
3. Disconnect this equipment from any AC outlet before cleaning. Use a damp cloth. Do not use liquid or spray detergents for cleaning.
4. For plug-in equipment, the power outlet socket must be located near the equipment and must be easily accessible.
5. Keep this equipment away from humidity.
6. Put this equipment on a stable surface during installation. Dropping it or letting it fall may cause damage.
7. The openings on the enclosure are for air convection to protect the equipment from overheating. **DO NOT COVER THE OPENINGS.**
8. Make sure the voltage of the power source is correct before connecting the equipment to the power outlet.
9. Place the power cord in a way so that people will not step on it. Do not place anything on top of the power cord. Use a power cord that has been approved for use with the product and that it matches the voltage and current marked on the product's electrical range label. The voltage and current rating of the cord must be greater than the voltage and current rating marked on the product.
10. All cautions and warnings on the equipment should be noted.
11. If the equipment is not used for a long time, disconnect it from the power source to avoid damage by transient overvoltage.
12. Never pour any liquid into an opening. This may cause fire or electrical shock.
13. Never open the equipment. For safety reasons, the equipment should be opened only by qualified service personnel.
14. If one of the following situations arises, get the equipment checked by service personnel:
 - a. The power cord or plug is damaged.
 - b. Liquid has penetrated into the equipment.
 - c. The equipment has been exposed to moisture.
 - d. The equipment does not work well, or you cannot get it to work according to the user's manual.
 - e. The equipment has been dropped and damaged.
 - f. The equipment has obvious signs of breakage.
15. Do not place heavy objects on the equipment.
16. The unit uses a three-wire ground cable which is equipped with a third pin to ground the unit and prevent electric shock. Do not defeat the purpose of this pin. If your outlet does not support this kind of plug, contact your electrician to replace your obsolete outlet.
17. **CAUTION: DANGER OF EXPLOSION IF BATTERY IS INCORRECTLY REPLACED. REPLACE ONLY WITH THE SAME OR EQUIVALENT TYPE RECOMMENDED BY THE MANUFACTURER. DISCARD USED BATTERIES ACCORDING TO THE MANUFACTURER'S INSTRUCTIONS.**

Technical Support and Assistance

1. For the most updated information of NEXCOM products, visit NEXCOM's website at www.nexcom.com.
2. For technical issues that require contacting our technical support team or sales representative, please have the following information ready before calling:
 - Product name and serial number
 - Detailed information of the peripheral devices
 - Detailed information of the installed software (operating system, version, application software, etc.)
 - A complete description of the problem
 - The exact wordings of the error messages

Warning!

1. Handling the unit: carry the unit with both hands and handle it with care.
2. Maintenance: to keep the unit clean, use only approved cleaning products or clean with a dry cloth.

Conventions Used in this Manual



Warning:

Information about certain situations, which if not observed, can cause personal injury. This will prevent injury to yourself when performing a task.



Caution:

Information to avoid damaging components or losing data.



Note:

Provides additional information to complete a task easily.

Global Service Contact Information

Headquarters

NEXCOM International Co., Ltd.

9F, No. 920, Chung-Cheng Rd.,
ZhongHe District, New Taipei City, 23586,
Taiwan, R.O.C.

Tel: +886-2-8226-7786

Fax: +886-2-8226-7782

www.nexcom.com

America

USA

NEXCOM USA

2883 Bayview Drive,
Fremont CA 94538, USA

Tel: +1-510-656-2248

Fax: +1-510-656-2158

Email: sales@nexcom.com

www.nexcom.com

Asia

Taiwan

NEXCOM Intelligent Systems

Taipei Office

13F, No.920, Chung-Cheng Rd.,
ZhongHe District,
New Taipei City, 23586, Taiwan, R.O.C.

Tel: +886-2-8226-7796

Fax: +886-2-8226-7792

Email: sales@nexcom.com.tw

www.nexcom.com.tw

NEXCOM Intelligent Systems

Taichung Office

16F, No.250, Sec. 2, Chongde Rd.,
Beitun Dist.,

Taichung City 406, R.O.C.

Tel: +886-4-2249-1179

Fax: +886-4-2249-1172

Email: sales@nexcom.com.tw

www.nexcom.com.tw

Japan

NEXCOM Japan

9F, Tamachi Hara Bldg.,
4-11-5, Shiba Minato-ku,
Tokyo, 108-0014, Japan

Tel: +81-3-5419-7830

Fax: +81-3-5419-7832

Email: sales@nexcom-jp.com

www.nexcom-jp.com

China

NEXCOM China

Floor 5, No.4, No.7 fengxian middle Rd.,
(Beike Industrial Park), Haidian District,
Beijing, 100094, China

Tel: +86-10-5704-2680

Fax: +86-10-5704-2681

Email: sales@nexcom.cn

www.nexcom.cn

NEXCOM Shanghai

Room 603/604, Huiyinmingzun Plaza Bldg., 1,
No.609, Yunlin East Rd.,
Shanghai, 200333, China
Tel: +86-21-5278-5868
Fax: +86-21-3251-6358
Email: sales@nexcom.cn
www.nexcom.cn

NEXCOM Surveillance Technology Corp.

Room202, Building B,
the GuangMing Industrial Zone Zhonghua Rd.,
Minzhi Street, Longhua District,
Shenzhen 518131, China
Tel: +86-755-8364-7768
Fax: +86-755-8364-7738
Email: steveyang@nexcom.com.tw
www.nexcom.cn

NEXCOM United System Service

Hui Yin Ming Zun Building Room 1108,
Building No. 11, 599 Yunling Road, Putuo District,
Shanghai, 200062, China
Tel: +86-21-6125-8282
Fax: +86-21-6125-8281
Email: frankyang@nexcom.cn
www.nexcom.cn

Europe**United Kingdom****NEXCOM EUROPE**

10 Vincent Avenue,
Crownhill Business Centre,
Milton Keynes, Buckinghamshire
MK8 0AB, United Kingdom
Tel: +44-1908-267121
Fax: +44-1908-262042
Email: sales.uk@nexcom.eu
www.nexcom.eu

Italy**NEXCOM ITALIA S.r.l**

Via Lanino 42,
21047 Saronno (VA), Italia
Tel: +39 02 9628 0333
Fax: +39 02 9625 570
Email: nexcomitalia@nexcom.eu
www.nexcomitalia.it

Package Contents

Before continuing, verify that the NISE 107 package that you received is complete. Your package should have all the items listed in the following table.

Item	Part Number	Name	Description	Qty
1	4NCPF00309X00	Terminal Blocks 3P Phoenix Contact:1827716	3.81mm Female DIP Green	1
2	4NCPM00302X00	Terminal Blocks 3P Phoenix Contact:1777992	5.08mm Male DIP Green	1
3	50311F0295X00	Flat Head Screw Long Fei:F2x4 NYLOK NIGP	F2x4 NIGP NYLOK	1
4	50311F0326X00	Flat Head Screw Long Fei:F3x5 NYLOK NI+Heat Treatment	F3x5 NYLOK NI+Heat Treatment	4
5	50311F0330X00	Round Head Screw Long Fei:P2x3 ISO+NYLON	P2x3 NI NYLOK	2
6	50311F0141X00	I Head Screw Long Fei: I M2.5*3L ISO NI	I M2.5x3L Head:DIA 5.5 ISO NI	1
7	5060900226X00	Mini PCIe Bracket CHYUAN-JYH	29x30x2.1mm SPCC t=1.0mm NI	1
8	6012200052X00	PE Zipper Bag #8	170x240mm, w/China RoHS Symbol	1
9	6012200053X00	PE Zipper Bag #3	100x70mm, w/China RoHS Symbol	2
10	60177A0616X00	NISE 107 Quick Reference Guide VER:A SIZE:A4	KRAMER	1
11	602DCD1533X00	NISE 107 DVD Driver VER:1.0	JCL	1

Ordering Information

The following information below provides ordering information for NISE 107.

NISE 107 (P/N: 10J00010701X0)

Intel Atom® x5-E3930 Dual Core, 1.80GHz Fanless System

NISE 107-E3940 (P/N: 10J00010700X0)

Intel Atom® x5-E3940 Quad Core, 1.80GHz Fanless System

NISE 107-POE (P/N: 10J00010702X0)

Intel Atom® x5-E3940 Quad Core, 1.80GHz fanless system

- **24V, 60W AC/DC power adapter w/o power cord (P/N: 7400060033X00)**

CHAPTER 1: PRODUCT INTRODUCTION

NISE 107/NISE 107-E3940 Overview



NISE 107/NISE 107-E3940 Front View



NISE 107/NISE 107-E3940 Rear View

Key Features

- Onboard Intel Atom® x5-E3930 Dual Core Processor, 1.80 GHz (NISE 107)
- Onboard Intel Atom® x5-E3940 Quad Core Processor, 1.80 GHz (NISE 107-E3940)
- 2 x Display output, 1 x DVI-D and 1 x DisplayPort port
- 2 x Intel® I210IT GbE LAN ports; support WoL, teaming and PXE
- Support both 2.5" HDD and M.2 (front access)
- 1 x mini-PCIe slot support Wi-Fi/LTE wireless module
- 4 x USB 3.0
- 2 x DB9 for RS232/422/485
- 2 x optional DB9 for RS232 by request
- Support -20°C~70 degree C extended operating temperature (NISE 107)
- Support -5~55 degree C operating operating temperature (NISE 107-E3940)
- Support 9~30V DC input; support ATX power mode

NISE 107-POE Overview



NISE 107-POE Front View



NISE 107-POE Rear View

Key Features

- Onboard Intel Atom® x5-E3940 Quad Core processor, 1.80 GHz
- 2 x Display output, 1 x DVI-D and 1 x DP port
- 2 x Intel® I210IT GbE LAN ports; support WoL, teaming and PXE, LAN1 with PoE function (802.3af compliance)
- Support both 2.5" HDD and M.2 (front access)
- 1 x mini-PCIe slot support Wi-Fi/LTE wireless module
- 4 x USB 3.0
- 2 x DB9 for RS232/422/485
- 2 x DB9 for RS232
- Support -5~55 degree C operating temperature
- Support 9~30V DC input; support ATX power mode

Hardware Specifications

CPU Support

- **NISE 107:** Onboard Intel Atom® x5-E3930 dual core processor, 1.80 GHz, 2M Cache
- **NISE 107-E3940:** Onboard Intel Atom® x5-E3940 quad core processor, 1.80 GHz, 2M Cache
- **NISE 107-POE:** Onboard Intel Atom® x5-E3940 quad core processor, 1.80 GHz, 2M Cache

Main Memory

- 1 x DDR3L SO-DIMM socket, support DDR3L 1866 4GB RAM max., un-buffered and non-ECC

Display Option

- Dual independent display: DVI-D + DP

I/O Interface - Front

- ATX power on/off switch
- LED indicator: power status, HDD access, RTC battery low, Tx/Rx, GPO programmable LEDs
- 2 x DB9 for RS232/422/485 with auto flow control
- 2 x DB9 for RS232 (**NISE 107-POE**)
- 1 x External M.2 socket support B, B+M key module
- 1 x SIM card holder
- 1 x Optional I/F opening for optional function output or module interface use

I/O Interface - Rear

- 1 x DisplayPort
- 1 x DVI-D port

- 4 x USB 3.0 ports (900mA per each)
- 2 x Intel® I210IT GbE LAN ports; support WoL, teaming and PXE
- 1 x Line-out and 1 x Mic-in
- 2 x Antenna holes for optional Wi-Fi/3.5G antenna
- 1 x 3-pin DC input, support +9 to 30VDC input
- 1 x 3-pin Remote power on/off switch

I/O Interface - Internal

- 4 x GPI and 4 x GPO (5V, TTL type)

Storage Device

- 1 x 2.5" HDD (SATA 3.0)
- 1 x M.2, support B, B+M key module

Expansion Slot

- 1 x mini-PCIe socket support optional Wi-Fi/4G LTE/3.5G modules

Power Requirements

- Power input: +9 to 30 Vdc
- 1 x Optional 24V, 60W power adapter

Dimensions

- **NISE 107:**
185mm (W) x 131mm (D) x 54mm (H) without wall-mount bracket
- **NISE 107-E3940:**
185mm (W) x 131mm (D) x 54mm (H) without wall-mount bracket
- **NISE 107-POE:**
185mm (W) x 131mm (D) x 69mm (H) without wall-mount bracket

Construction

- Aluminum chassis with fanless design

Environment

- Operating temperature:
 - Ambient with air flow: -20°C to 70°C (**NISE 107**)
 - Ambient with air flow: -5°C to 55°C (**NISE 107-E3940 & NISE 107-POE**)
(According to IEC60068-2-1, IEC60068-2-2, IEC60068-2-14)
- Storage temperature: -20°C to 80°C
- Relative humidity: 95% at 40 degree C
- Shock protection:
 - HDD: 20G @ wall mount, half sine, 11ms (operation), IEC60068 2-27
 - M.2: 50G @ wall mount, half sine, 11ms (operation), IEC60068 2-27
- Vibration protection w/ HDD condition:
 - Random: 0.5Grms @ 5~500 Hz, IEC60068-2-64
 - Sinusoidal: 0.5Grms @ 5~500 Hz, IEC60068-2-6
- Vibration protection w/ M.2 & SSD condition:
 - Random: 2Grms @ 5~500 Hz, IEC60068-2-64
 - Sinusoidal: 2Grms @ 5~500 Hz, IEC60068-2-6

Certifications

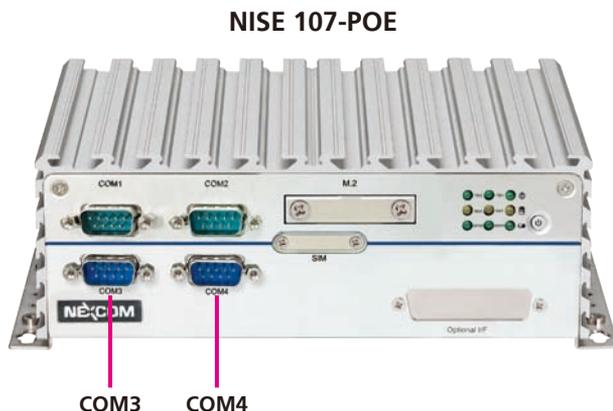
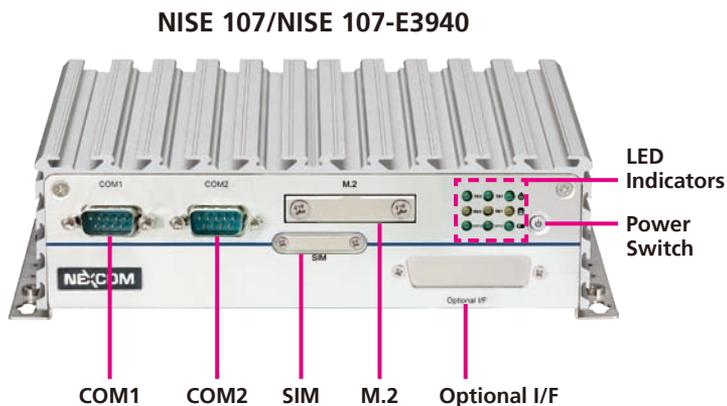
- CE approval
 - EN61000-6-2
 - EN61000-6-4
- FCC Class A

OS Support List

- Windows 10 IoT Enterprise, 64-bit
- Linux Kernel version 4.1

Knowing Your NISE 107 Series

Front Panel



COM1 & COM2

Two DB9 ports used to connect RS232/422/485 compatible devices.

COM3 & COM4 (NISE 107-POE)

Two DB9 ports used to connect RS232 compatible devices.

M.2 and SIM Card Slot

Used to install an M.2 and a SIM card.

Optional I/F

Expansion slot for optional function output or module interface use.

LED Indicators

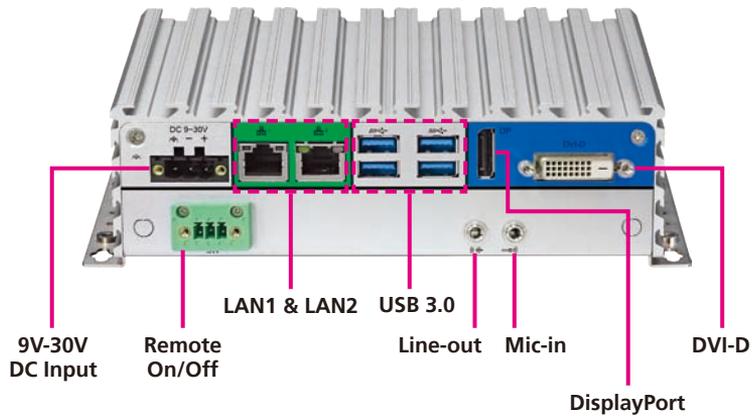
Indicates the power status, RTC battery status, storage activity, serial port send (Tx), transmit (Rx) and GPO activity of the system. The GPO LEDs are programmable.

Power Switch

Press to power-on or power-off the system.

Rear Panel

NISE 107/NISE 107-E3940



NISE 107-POE



9V-30V DC Input

Used to plug a DC power cord.

Remote On/Off Switch

Used to connect a remote to power on/off the system.

LAN1 & LAN2

Used to connect the system to a local area network.

USB 3.0

Used to connect USB 3.0/2.0 devices.

Line-out

Used to connect a headphone or a speaker.

Mic-in

Used to connect an external microphone.

DisplayPort

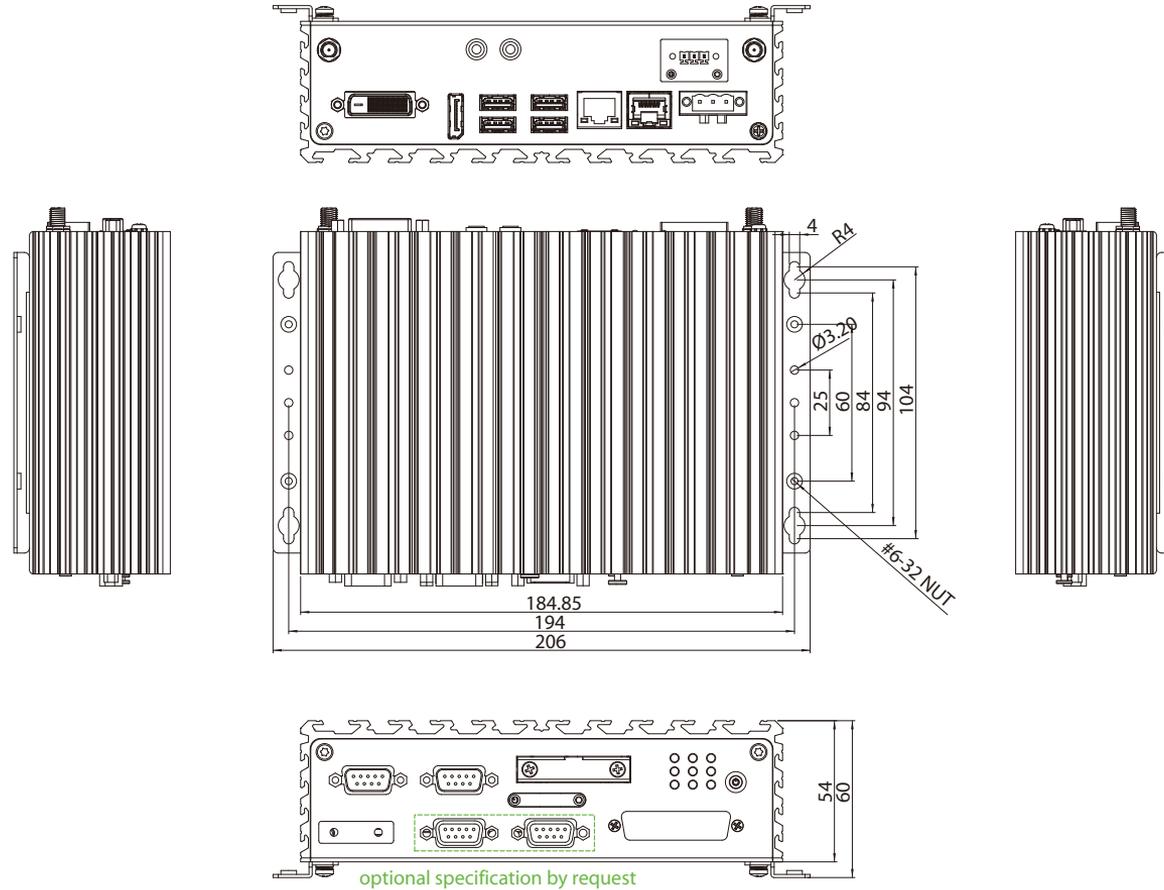
Used to connect a DisplayPort interface monitor.

DVI-D

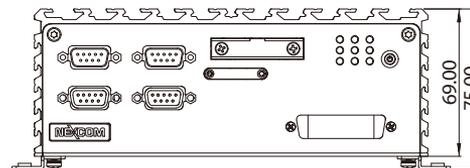
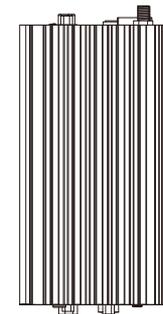
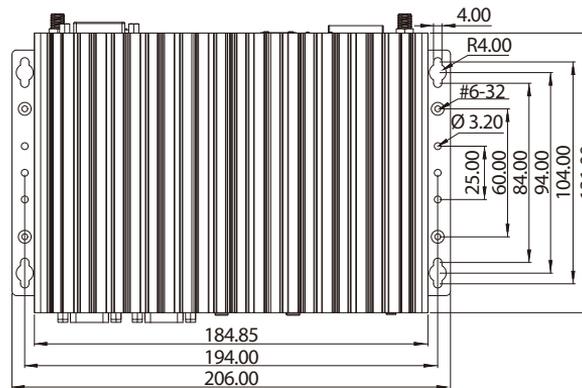
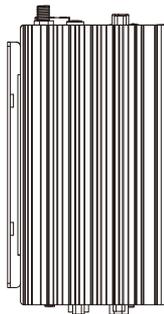
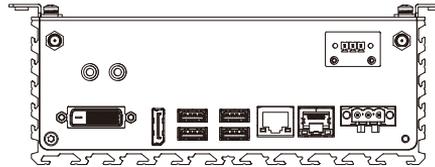
Used to connect a DVI-D interface monitor.

Mechanical Dimensions

NISE 107 & NISE 107-E3940



NISE 107-POE



CHAPTER 2: JUMPERS AND CONNECTORS

This chapter describes how to set the jumpers and connectors on the NISE 107 motherboard.

Before You Begin

- Ensure you have a stable, clean working environment. Dust and dirt can get into components and cause a malfunction. Use containers to keep small components separated.
- Adequate lighting and proper tools can prevent you from accidentally damaging the internal components. Most of the procedures that follow require only a few simple tools, including the following:
 - A Philips screwdriver
 - A flat-tipped screwdriver
 - A set of jewelers screwdrivers
 - A grounding strap
 - An anti-static pad
- Using your fingers can disconnect most of the connections. It is recommended that you do not use needle-nosed pliers to disconnect connections as these can damage the soft metal or plastic parts of the connectors.
- Before working on internal components, make sure that the power is off. Ground yourself before touching any internal components, by touching a metal object. Static electricity can damage many of the electronic components. Humid environments tend to have less static electricity than

dry environments. A grounding strap is warranted whenever danger of static electricity exists.

Precautions

Computer components and electronic circuit boards can be damaged by discharges of static electricity. Working on computers that are still connected to a power supply can be extremely dangerous.

Follow the guidelines below to avoid damage to your computer or yourself:

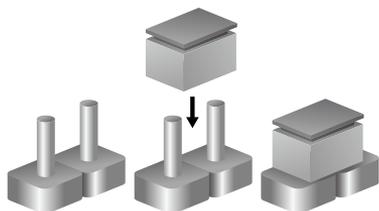
- Always disconnect the unit from the power outlet whenever you are working inside the case.
- If possible, wear a grounded wrist strap when you are working inside the computer case. Alternatively, discharge any static electricity by touching the bare metal chassis of the unit case, or the bare metal body of any other grounded appliance.
- Hold electronic circuit boards by the edges only. Do not touch the components on the board unless it is necessary to do so. Don't flex or stress the circuit board.
- Leave all components inside the static-proof packaging that they shipped with until they are ready for installation.
- Use correct screws and do not over tighten screws.

Jumper Settings

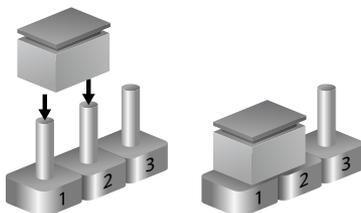
A jumper is the simplest kind of electric switch. It consists of two metal pins and a cap. When setting the jumpers, ensure that the jumper caps are placed on the correct pins. When the jumper cap is placed on both pins, the jumper is short. If you remove the jumper cap, or place the jumper cap on just one pin, the jumper is open.

Refer to the illustrations below for examples of what the 2-pin and 3-pin jumpers look like when they are short (on) and open (off).

Two-Pin Jumpers: Open (Left) and Short (Right)



Three-Pin Jumpers: Pins 1 and 2 are Short

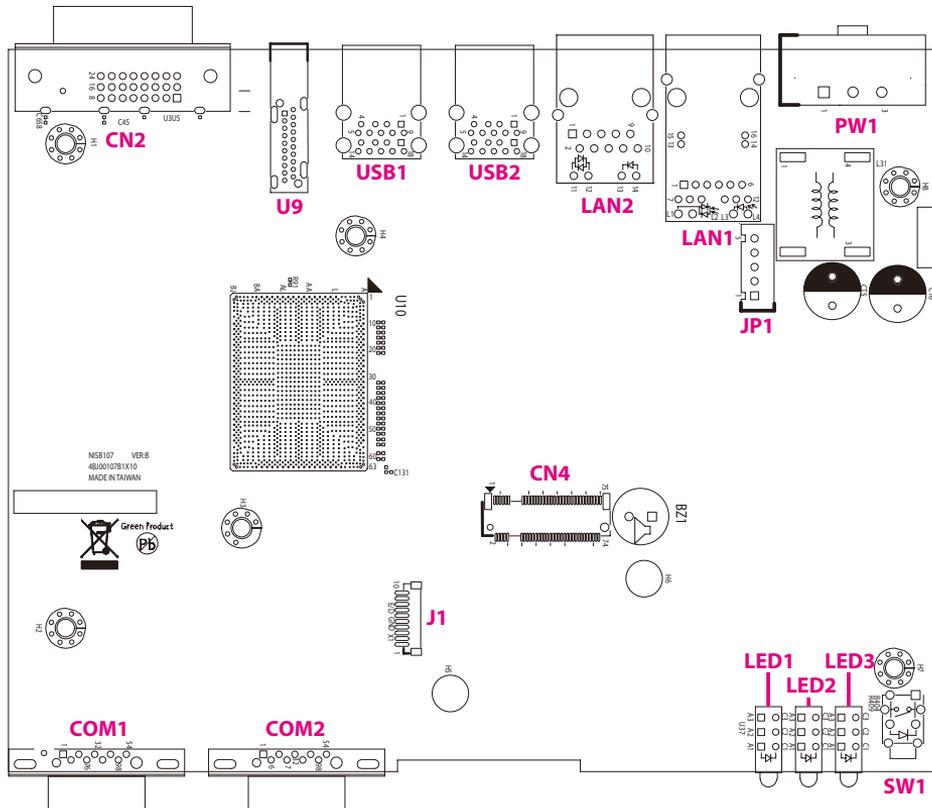


Locations of the Jumpers and Connectors for NISB 107

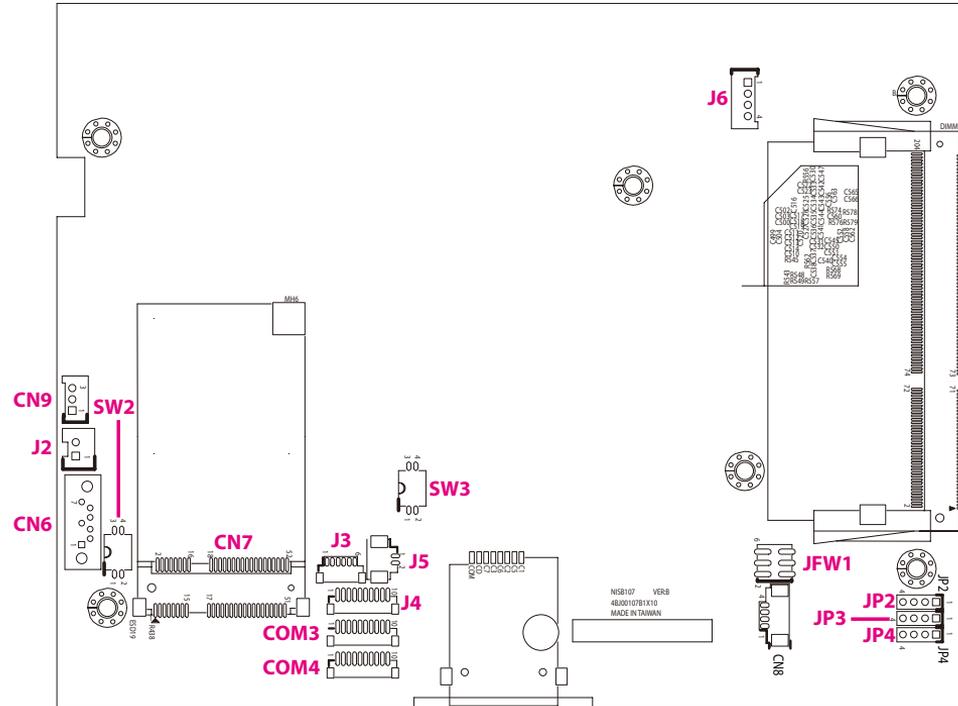
NISB 107

The following figures are the top and bottom view of the NISB 107 main board which is the main board used in NISE 107. It shows the locations of the jumpers and connectors.

Top View



Bottom View

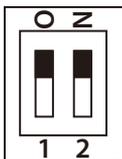


Jumpers and DIP Switches

AT/ATX Power Select

Connector type: 2x2 DIP switch

Connector location: SW2



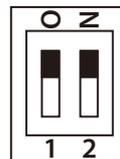
Pin	Settings
1 ON, 2 OFF	AT Mode
1 OFF, 2 ON	ATX Mode

Pin	Definition
1	AT_PWRBT#
2	PBT_TR1
3	GND
4	PWRBTN#

RTC RTEST Switch (RTC Clear)

Connector type: 2x2 DIP switch

Connector location: SW3



Pin	Settings
1 OFF, 2 OFF	Normal (Default)

Pin	Definition
1	RTEST#
2	SRTCST#
3	GND
4	GND

Connector Pin Definitions

External I/O Interfaces - Front Panel

Power Button

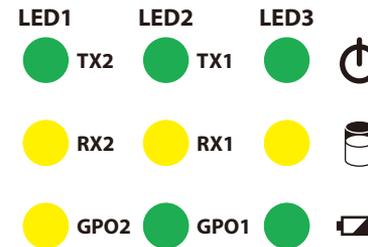
Connector location: SW1



Pin	Definition	Pin	Definition
1	GND	2	GND
3	GND	4	GND
A1	PWRLED_N	C1	PWRLED_P

LED Indicators

Connector location: LED1, LED2 and LED3

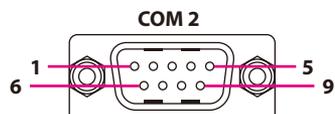


	Pin	Definition	Pin	Definition
LED1	A1	GPO_PR2LED	C1	GPO_PR2
	A2	COM2_TXLEDP	C2	COM2_TXLEDN
	A3	COM2_RXLEDP	C3	COM2_RXLEDN
LED2	A1	GPO_PR1LED	C1	GPO_PR1
	A2	COM1_RXLEDP	C2	COM1_RXLEDN
	A3	COM1_TXLEDP	C3	COM1_TXLEDN
LED3	A1	3VSB	C1	BATTERY_LED
	A2	VCC3	C2	SATA_LED_N
	A3	VCC3	C3	PWR_LED_N

COM 2 Port

Connector type: DB-9 port, 9-pin D-Sub

Connector location: COM2

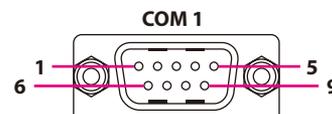


Pin	Definition	Pin	Definition
1	SP2_DCD	2	SP2_RXD
3	SP2_TXD	4	SP2_DTR
5	GND	6	SP2_DSR
7	SP2_RTS	8	SP2_CTS
9	SP2_RI		

COM 1 Port

Connector type: DB-9 port, 9-pin D-Sub

Connector location: COM1



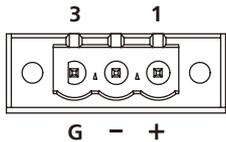
Pin	Definition	Pin	Definition
1	SP1_DCD	2	SP1_RXD
3	SP1_TXD	4	SP1_DTR
5	GND	6	SP1_DSR
7	SP1_RTS	8	SP1_CTS
9	SP1_RI		

External I/O Interfaces - Rear Panel

9V - 30V DC Power Input

Connector type: Phoenix Contact 1x3 3-pin terminal block

Connector location: PW1

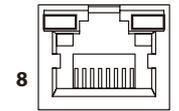


Pin	Definition
1	VIN_1
2	VIN_VSS
3	Chassis1_GND

LAN1 Port

Connector type: RJ45 port

Connector location: LAN1

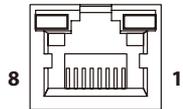


Pin	Definition	Pin	Definition
1	NC	2	LAN_MDI2N_1
3	LAN_MDI2P_1	4	LAN_MDI1P_1
5	LAN_MDI1N_1	6	NC
7	NC	8	LAN_MDI3P_1
9	LAN_MDI3N_1	10	LAN_MDI0N_1
11	LAN_MDI0P_1	12	NC
13	VPORT_POS_ALT_A	14	VPORT_NEG_ALT_A
15	NC	16	NC
L1	LAN_LED_LINK1G#	L2	LAN_LINK
L3	LAN_LED_ACT#	L4	LAN_ACTPW
NH1	NC	NH2	NC
MH1	CH_GND_FRONT	MH2	CH_GND_FRONT

LAN2 Port

Connector type: RJ45 port

Connector location: LAN2

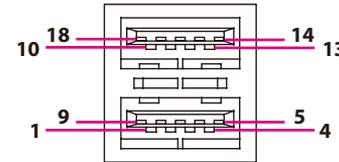


Pin	Definition	Pin	Definition
1	LAN2_MDI0P	2	LAN2_MDI0N
3	LAN2_MDI1P	4	LAN2_MDI1N
5	LAN2TCT	6	LAN1TCTG
7	LAN2_MDI2P	8	LAN2_MDI2N
9	LAN2_MDI3P	10	LAN2_MDI3N
11	LAN2_LED_LINK1G#	12	LAN2_LINK
13	LAN2_LED_ACT#	14	LAN2_ACTPW
NH1	NC	NH2	NC
MH1	CH_GND_FRONT	MH2	CH_GND_FRONT

USB 3.0 Ports

Connector type: Dual USB 3.0 port

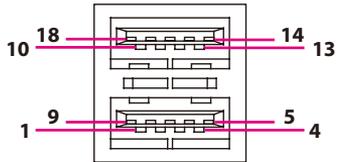
Connector location: USB2



Pin	Definition	Pin	Definition
1	P5V_USB_P1	2	USB2_N1_C
3	USB2_P1_C	4	GND
5	USB3_RX0N_C	6	USB3_RX0P_C
7	GND	8	USB3_TX0N_C
9	USB3_TX0P_C	10	P5V_USB_P1
11	USB2_N2_C	12	USB2_P2_C
13	GND	14	USB3_RX1N_C
15	USB3_RX1P_C	16	GND
17	USB3_TX1N_C	18	USB3_TX1P_C
MH1	CH_GND_FRONT	MH2	CH_GND_FRONT
MH3	CH_GND_FRONT	MH4	CH_GND_FRONT

USB 3.0 Ports

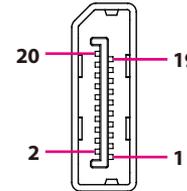
Connector type: Dual USB 3.0 port
Connector location: USB1



Pin	Definition	Pin	Definition
1	P5V_USB_P3	2	USB2_N3_C
3	USB2_P3_C	4	GND
5	USB3_RX2N_C	6	USB3_RX2P_C
7	GND	8	USB3_TX2N_C
9	USB3_TX2P_C	10	P5V_USB_P3
11	USB2_N4_C	12	USB2_P4_C
13	GND	14	USB3_RX3N_C
15	USB3_RX3P_C	16	GND
17	USB3_TX3N_C	18	USB3_TX3P_C
MH1	CH_GND_FRONT	MH2	CH_GND_FRONT
MH3	CH_GND_FRONT	MH4	CH_GND_FRONT

DisplayPort

Connector type: DisplayPort
Connector location: U9

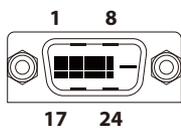


Pin	Definition	Pin	Definition
1	DP_DATA0_P_C	2	GND
3	DP_DATA0_N_C	4	DP_DATA1_P_C
5	GND	6	DP_DATA1_N_C
7	DP_DATA2_P_C	8	GND
9	DP_DATA2_N_C	10	DP_DATA3_P_C
11	GND	12	DP_DATA3_N_C
13	DPC_CONFIG1	14	DPC_CONFIG2
15	DPC_AUXP_C	16	GND
17	DPC_AUXN_C	18	DDIOHPD0
19	GND	20	DP_PWR
NH1	NC	NH2	NC
MH1	CH_GND_FRONT	MH2	CH_GND_FRONT
MH3	CH_GND_FRONT	MH4	CH_GND_FRONT

DVI-D Connector

Connector type: 24-pin D-Sub, 2.0mm-M-180 (DVI)

Connector location: CN2



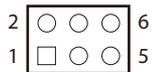
Pin	Definition	Pin	Definition
1	DVI_DATA2_N_C	2	DVI_DATA2_P_C
3	GND	4	NC
5	NC	6	DVI_CTRL_CLK
7	DVI_CTRL_DAT	8	NC
9	DVI_DATA1_N_C	10	DVI_DATA1_P_C
11	GND	12	NC
13	NC	14	DVI_PWR
15	GND	16	DDI1HPD0
17	DVI_DATA0_N_C	18	DVI_DATA0_P_C
19	DVI_DATA1_N_C	20	NC
21	NC	22	GND
23	DVI_CLK_P_C	24	DVI_CLK_N_C

Internal Connectors

FW BIOS Connector

Connector type: 2x3 6-pin header, 2.0mm pitch

Connector location: JFW1

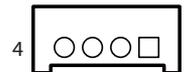


Pin	Definition	Pin	Definition
1	VSPI	2	GND
3	VSPI	4	BIOS_SPI_CLK
5	BIOS_SPI_SO	6	BIOS_SPI_SI

USB 2.0 Connector

Connector type: 1x4 4-pin header JST, 2.0mm pitch

Connector location: J6



Pin	Definition
1	P5V_USB_P2
2	USB2_N7_C
3	USB2_P7_C
4	GND

Port 80 Connector

Connector type: 1x10 10-pin header, 1.0mm pitch

Connector location: J1



Pin	Definition	Pin	Definition
1	GND	2	PLTRST_N
3	LPC_CLK0_DEBUG	4	LPC_FRAME#
5	LPC_AD3	6	LPC_AD2
7	LPC_AD1	8	LPC_ADO
9	INT_SERIRQ_C	10	VCC3

COM Port 3 Connector

Connector type: 1x10 10-pin header, 1.0mm pitch

Connector location: COM3



Pin	Definition	Pin	Definition
1	SP3_DCD#_R	2	SP3_RXD_R
3	SP3_TXD_R	4	SP3_DTR#_R
5	GND	6	SP3_DSR#_R
7	SP3_RTS#_R	8	SP3_CTS#_R
9	SP3_RI#_R	10	GND

COM Port 4 Connector

Connector type: 1x10 10-pin header, 1.0mm pitch

Connector location: COM4

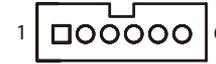


Pin	Definition	Pin	Definition
1	SP4_DCD#_R	2	SP4_RXD_R
3	SP4_TXD_R	4	SP4_DTR#_R
5	GND	6	SP4_DSR#_R
7	SP4_RTS#_R	8	SP4_CTS#_R
9	SP4_RI#_R	10	GND

GPS Connector

Connector type: 1x6 6-pin header JST, 1.0mm pitch

Connector location: J3

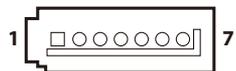


Pin	Definition	Pin	Definition
1	GPS_BAT	2	NC
3	COM3_TXD	4	COM3_RXD
5	GND	6	VCC3
MH1	GND	MH2	GND

SATA Connector

Connector type: Standard Serial ATA 7P (1.27mm, SATA-M-180)

Connector location: CN6



Pin	Definition	Pin	Definition
1	GND	2	SATA_TXP1_C
3	SATA_TXN1_C	4	GND
5	SATA_RXN1_C	6	SATA_RXP1_C
7	GND		

SATA Power Connector

Connector type: 1x2 2-pin header, 2.5mm pitch

Connector location: J2

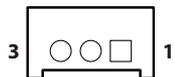


Pin	Definition
1	GND
2	VCC5

Remote Button/S3 Connector

Connector type: 1x3 3-pin header JST, 2.0mm pitch

Connector location: CN9



Pin	Definition
1	REMOTE_S3
2	GND
3	PBT_TR_C

RTC Connector

Connector type: 1x2 2-pin header, 1.25mm pitch

Connector location: J5



Pin	Definition
1	GND
2	BATIN

GPIO Connector

Connector type: 1x10 10-pin header, 1.0mm pitch

Connector location: J4



Pin	Definition	Pin	Definition
1	VCC5	2	GND
3	ICH_GPO0_OUT	4	ICH_GPIO_IN
5	ICH_GPO1_OUT	6	ICH_GPI1_IN
7	ICH_GPO2_OUT	8	ICH_GPI2_IN
9	ICH_GPO3_OUT	10	ICH_GPI3_IN

Mic-in Connector

Connector type: 1x4 4-pin header, 2.0mm pitch

Connector location: JP2



Pin	Definition
1	MIC1_L3
2	GND
3	MIC_JD
4	MIC1_R3

Line-out Connector

Connector type: 1x4 4-pin header, 2.0mm pitch

Connector location: JP4



Pin	Definition
1	LOUT_L3
2	GND
3	LINE_OUT_JD
4	LOUT_R3

Line-in Connector

Connector type: 1x4 4-pin header, 2.0mm pitch

Connector location: JP3

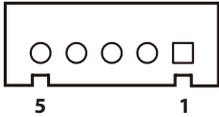


Pin	Definition
1	FLIN_L
2	GND
3	LIN_JD
4	FLIN_R

PoE Connector

Connector type: 1x5 5-pin header, 2.5mm pitch

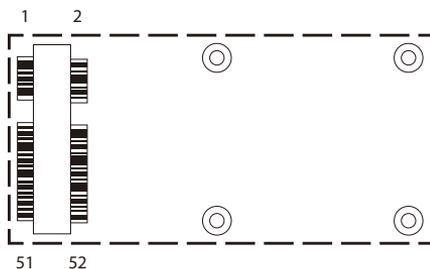
Connector location: JP1



Pin	Definition	Pin	Definition
1	VIN	2	GND
3	3VSB	4	VPORT_POS_ALT_A
5	VPORT_NEG_ALT_A		

Mini-PCIe Connector

Connector location: CN7



Pin	Definition	Pin	Definition
1	3P3_WAKE0#	2	3VSB_MINI1
3	NC	4	GND
5	NC	6	VCC1_5#1
7	PCIE_CLKREQ2#	8	UIM_PWR
9	GND	10	UIM_DATA
11	PCIE_CLKOUT2N	12	UIM_CLK
13	PCIE_CLKOUT2P	14	UIM_RESET
15	GND	16	UIM_VPP
17	NC	18	GND
19	NC	20	MINICARD1DIS#
21	GND	22	RST_MINIPCI1
23	RXN2_R	24	3VSB_MINI1
25	RXP2_R	26	GND

Pin	Definition	Pin	Definition
27	GND	28	VCC1_5#1
29	GND	30	SMB_CLK_3P3
31	TXN2_R	32	SMB_DATA_3P3
33	TXP2_R	34	GND
35	GND	36	USB2_N5C
37	GND	38	USB2_P5C
39	3VSB_MINI1	40	GND
41	3VSB_MINI1	42	NC
43	GND	44	NC
45	CL_CLK_C	46	NC
47	CL_DAT_C	48	VCC1_5#1
49	CL_RST#_C	50	GND
51	NC	52	3VSB_MINI1

M.2 Connector

Connector location: CN4



Pin	Definition	Pin	Definition
1	GND	2	3VSB
3	GND	4	3VSB
5	GND	6	
7	USB2_P6_C	8	N44177869
9	USB2_N6_C	10	
11	GND	12	
17		18	
19		20	
21		22	
23		24	
25		26	
27	GND	28	UIM_VPP1
29		30	UIM_RESET1
31		32	UIM_CLK1
33	GND	34	UIM_DATA1
35		36	UIM_PWR1
37		38	
39	GND	40	

Pin	Definition	Pin	Definition
41	PCIE_mSATA_RXP	42	
43	PCIE_mSATA_RXN	44	
45	GND	46	
47	PCIE_mSATA_TXN	48	
49	PCIE_mSATA_TXP	50	R CN4_PLTRST_C
51	GND	52	PCIE_CLKREQ3#
53	PCIE_CLKOUT3N	54	3P3_WAKE0#
55	PCIE_CLKOUT3P	56	
57	GND	58	
59		60	
61		62	
65		66	
67	M.2_RESET	68	SUS_CLK
69	PCIE_mSATA_SEL	70	3VSB
71	GND	72	3VSB
73	GND	74	3VSB
75	USB3_OTHER_SEL		

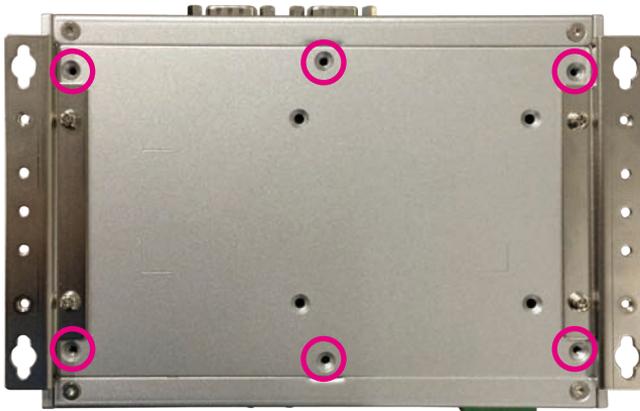
CHAPTER 3: SYSTEM SETUP

Removing the Chassis Cover

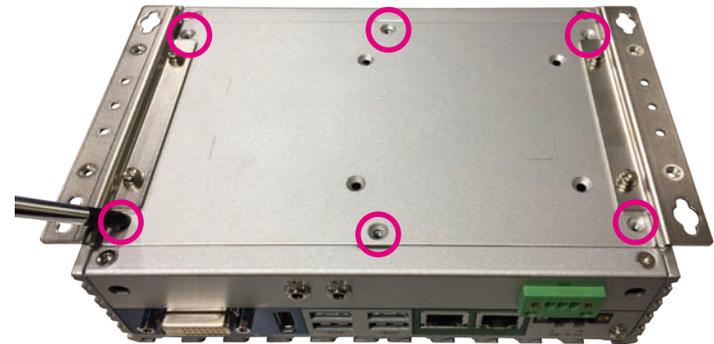


Prior to removing the chassis cover, make sure the unit's power is off and disconnected from the power sources to prevent electric shock or system damage.

1. Locate the 6 screws on the bottom side of the chassis cover.



2. Remove the 6 screws on the bottom side of the chassis cover.



3. Remove the chassis cover.



Installing a SO-DIMM Memory Module



Remove the bottom cover before installing a SO-DIMM.

1. Locate the SO-DIMM socket.



SO-DIMM Socket

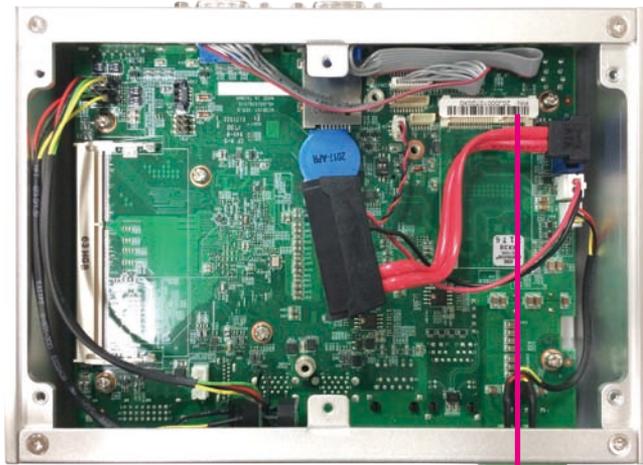
2. Insert the module into the socket at an approximately 30 degrees angle. The ejector tabs at the ends of the socket will automatically snap into the locked position to hold the module in place.



Memory Module

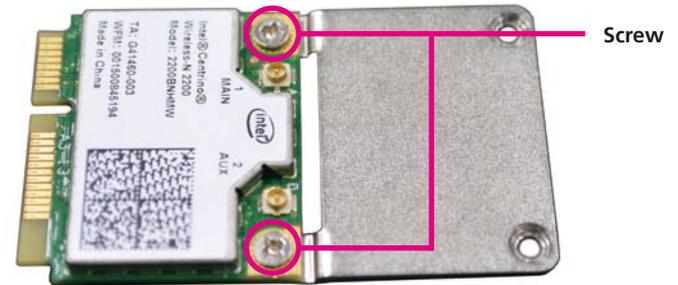
Installing a Wireless LAN Module (Half-size)

1. Locate the mini-PCIe slot on the board.



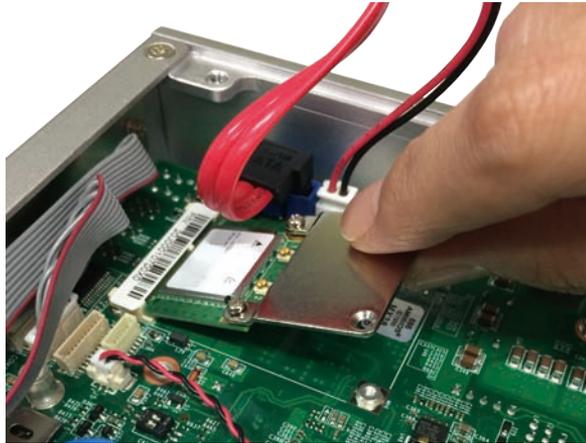
Mini-PCIe Slot

2. Install the mini-PCIe bracket to the mini-PCIe module.



Screw

3. Insert the mini-PCIe module into the mini-PCIe slot at 45 degree angle until the gold-plated connector on the edge of the module completely disappears into the slot.



4. Push the module down and secure it with a screw.



Installing a SIM Card

1. Release the SIM card cover.



2. Insert the SIM card into the slot.

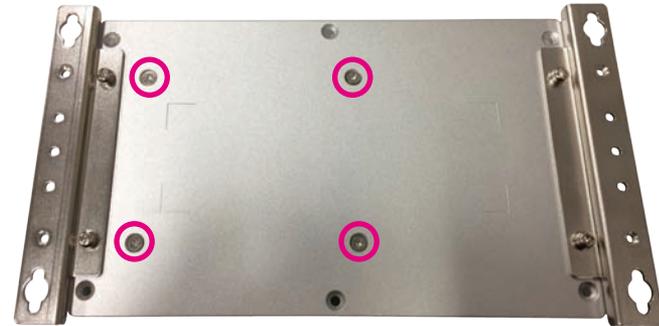


3. Close the cover and secure it to the original position.



Installing a SATA Storage Drive

1. The inner side of the bottom cover is where you will install the SATA drive. Align the mounting holes of the SATA drive with the mounting holes on the cover.
2. While supporting the SATA drive, turn the cover to the other side. This will be the outer side of the cover. Use the provided screws to secure the drive in place.



3. Connect the SATA data/power cable to the SATA drive.
4. Connect the SATA data/power cable to connectors CN6 and J2 on the motherboard respectively.



Installing an M.2 Card

1. Locate the M.2 tray at the front and remove the screws on it.



2. Remove the tray of the M.2 socket.



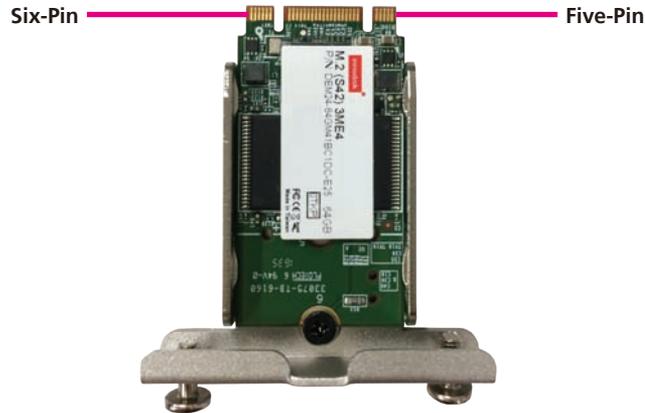
3. Insert the M.2 module into the tray.



4. Secure the module with a screw.



5. Make sure the gold-plated six-pin connector on the edge of the module is on the left, while the five-pin connector is on the right.



6. Insert the M.2 module and fasten the cover.



CHAPTER 4: BIOS SETUP

This chapter describes how to use the BIOS setup program for NISE 107. The BIOS screens provided in this chapter are for reference only and may change if the BIOS is updated in the future.

To check for the latest updates and revisions, visit the NEXCOM website at www.nexcom.com.tw.

About BIOS Setup

The BIOS (Basic Input and Output System) Setup program is a menu driven utility that enables you to make changes to the system configuration and tailor your system to suit your individual work needs. It is a ROM-based configuration utility that displays the system's configuration status and provides you with a tool to set system parameters.

These parameters are stored in non-volatile battery-backed-up CMOS RAM that saves this information even when the power is turned off. When the system is turned back on, the system is configured with the values found in CMOS.

With easy-to-use pull down menus, you can configure such items as:

- Hard drives, diskette drives, and peripherals
- Video display type and display options
- Password protection from unauthorized use
- Power management features

The settings made in the setup program affect how the computer performs. It is important, therefore, first to try to understand all the setup options, and second, to make settings appropriate for the way you use the computer.

When to Configure the BIOS

- This program should be executed under the following conditions:
 - When changing the system configuration
 - When a configuration error is detected by the system and you are prompted to make changes to the setup program
 - When resetting the system clock
 - When redefining the communication ports to prevent any conflicts
 - When making changes to the Power Management configuration
 - When changing the password or making other changes to the security setup

Normally, CMOS setup is needed when the system hardware is not consistent with the information contained in the CMOS RAM, whenever the CMOS RAM has lost power, or the system features need to be changed.

Default Configuration

Most of the configuration settings are either predefined according to the Load Optimal Defaults settings which are stored in the BIOS or are automatically detected and configured without requiring any actions. There are a few settings that you may need to change depending on your system configuration.

Entering Setup

When the system is powered on, the BIOS will enter the Power-On Self Test (POST) routines. These routines perform various diagnostic checks; if an error is encountered, the error will be reported in one of two different ways:

- If the error occurs before the display device is initialized, a series of beeps will be transmitted.
- If the error occurs after the display device is initialized, the screen will display the error message.

Powering on the computer and immediately pressing allows you to enter Setup.

Press the  key to enter Setup:

Legends

Key	Function
	Moves the highlight left or right to select a menu.
	Moves the highlight up or down between sub-menus or fields.
	Exits the BIOS Setup Utility.
	Scrolls forward through the values or options of the highlighted field.
	Scrolls backward through the values or options of the highlighted field.
	Selects a field.
	Displays General Help.
	Load previous values.
	Load optimized default values.
	Saves and exits the Setup program.
	Press <Enter> to enter the highlighted sub-menu

Scroll Bar

When a scroll bar appears to the right of the setup screen, it indicates that there are more available fields not shown on the screen. Use the up and down arrow keys to scroll through all the available fields.

Submenu

When “▶” appears on the left of a particular field, it indicates that a submenu which contains additional options are available for that field. To display the submenu, move the highlight to that field and press  .

BIOS Setup Utility

Once you enter the AMI BIOS Setup Utility, the Main Menu will appear on the screen. The main menu allows you to select from several setup functions and one exit. Use arrow keys to select among the items and press  to accept or enter the submenu.

Main

The Main menu is the first screen that you will see when you enter the BIOS Setup Utility.

System Date

The date format is <day>, <month>, <date>, <year>. Day displays a day, from Monday to Sunday. Month displays the month, from January to December. Date displays the date, from 1 to 31. Year displays the year, from 2005 to 2099.

System Time

The time format is <hour>, <minute>, <second>. The time is based on the 24-hour military-time clock. For example, 1 p.m. is 13:00:00. Hour displays hours from 00 to 23. Minute displays minutes from 00 to 59. Second displays seconds from 00 to 59.

Aptio Setup Utility - Copyright (C) 2017 American Megatrends, Inc.					
Main	Advanced	Chipset	Security	Boot	Save & Exit
BIOS Information			Set the Date. Use Tab to switch between Date elements.		
BIOS Vendor	American Megatrends		Default Ranges:		
Core Version	5.12		Year: 2005-2099		
Compliance	UEFI 2.5; PI 1.4		Months: 1-12		
Project Version	N107T002 x64		Days: dependent on month		
Build Date and Time	06/29/2017 15:32:50				
Access Level	Administrator				
Platform firmware Information					
BXT SOC	B1				
TXE FW	3.0.13.1144				
GOP	10.0.1036				
Memory Information			←→: Select Screen		
Total Memory	2048 MB		↑↓: Select Item		
Memory Speed	1866 MHz		Enter: Select		
System Date	[Wed 03/27/2013]		+/-: Change Opt.		
System Time	[23:40:30]		F1: General Help		
			F2: Previous Values		
			F3: Optimized Defaults		
			F4: Save & Exit		
			ESC: Exit		
Version 2.18.1263. Copyright (C) 2017 American Megatrends, Inc.					

Advanced

The Advanced menu allows you to configure your system for basic operation. Some entries are defaults required by the system board, while others, if enabled, will improve the performance of your system or let you set some features according to your preference.



Setting incorrect field values may cause the system to malfunction.



ACPI Settings

This section is used to configure ACPI settings.



Enable Hibernation

Enables or disables system ability to hibernate (OS/S4 Sleep State). This option may not be effective with some OS.

ACPI Sleep State

Select the highest ACPI sleep state the system will enter when the suspend button is pressed. The options are Suspend Disabled and S3 (Suspend to RAM).

IT8786E Super IO Configuration

This section is used to configure the I/O functions supported by the onboard Super I/O chip.



Super IO Chip

Displays the Super I/O chip used on the board.

Serial Port 1 Configuration

This section is used to configure serial port 1.



Serial Port

Enables or disables the serial port.

Onboard Serial Port Mode

Select this to change the serial port mode to RS232, RS422 or RS485.

Terminal Resistor

Enables or disables the terminal resistor.

Serial Port 2 Configuration

This section is used to configure serial port 2.



Serial Port

Enables or disables the serial port.

Onboard Serial Port Mode

Select this to change the serial port mode to RS232, RS422 or RS485.

Terminal Resistor

Enables or disables the terminal resistor.

Serial Port 3 Configuration

This section is used to configure serial port 3.



Serial Port

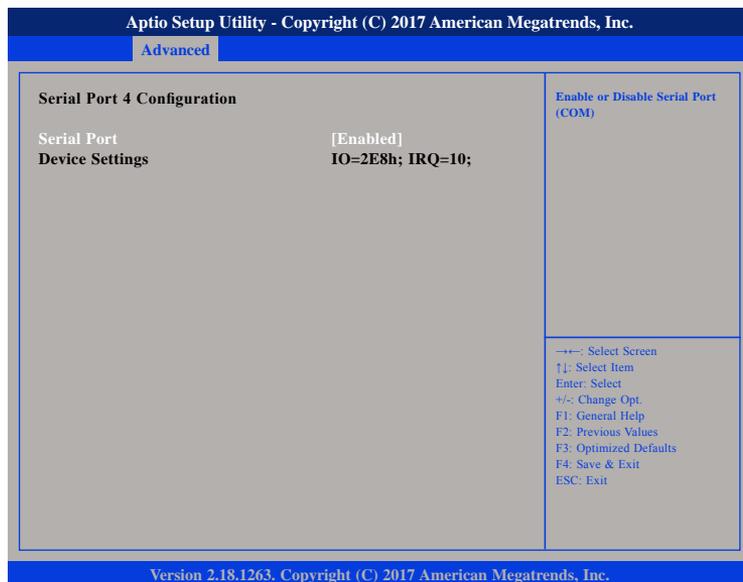
Enables or disables the serial port.

GPS

Enables or disables GPS.

Serial Port 4 Configuration

This section is used to configure serial port 4.

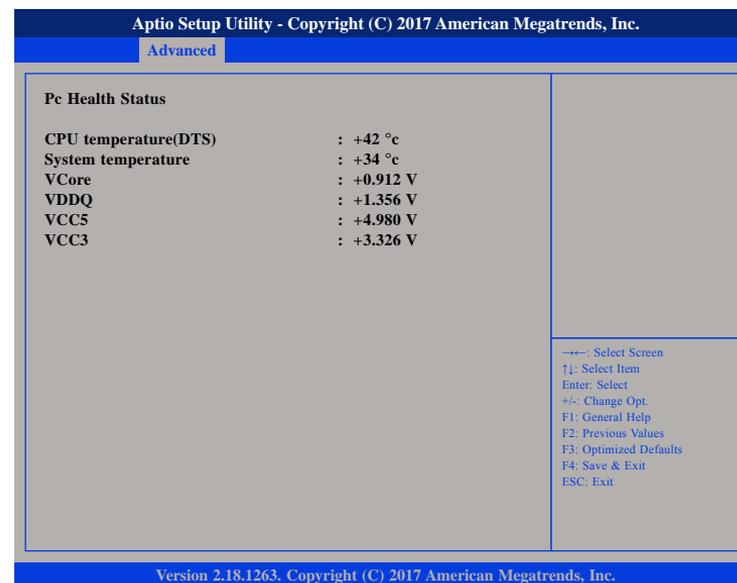


Serial Port

Enables or disables the serial port.

Hardware Monitor

This section is used to monitor hardware status such as temperature, fan speed and voltages.



CPU temperature(DTS)

Detects and displays the current CPU temperature.

System temperature

Detects and displays the current system temperature.

VCore to VCC3

Detects and displays the output voltages.

CPU Configuration

This section is used to configure the CPU.



Active Processor Cores

Select the number of cores to enable in each processor package.

Core 1

Enables or disables CPU core 1.

Intel® Virtualization Technology

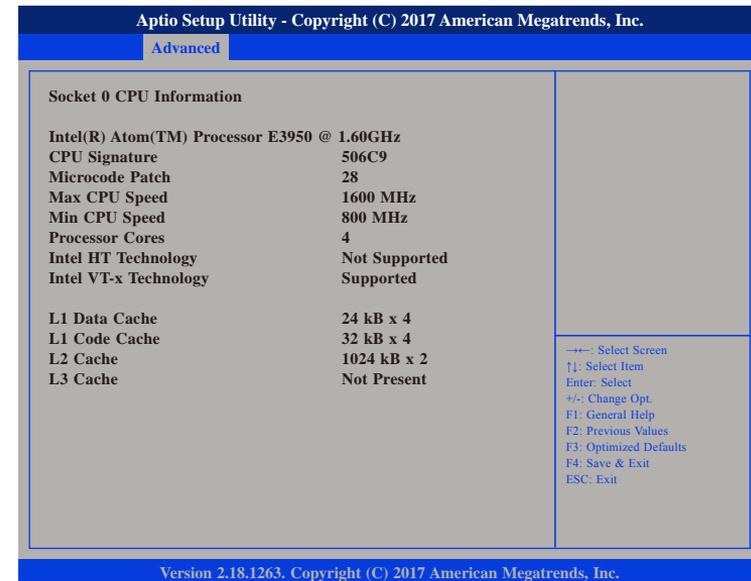
When this field is set to Enabled, the VMM can utilize the additional hardware capabilities provided by Vanderpool Technology.

VT-d

Enables or disables VT-d function on MCH.

Socket 0 CPU Information

Display information on the CPU installed on socket 0.



CPU Power Management



EIST

Enables or disables Intel® SpeedStep.

Network Stack

This section is used to configure the network stack.

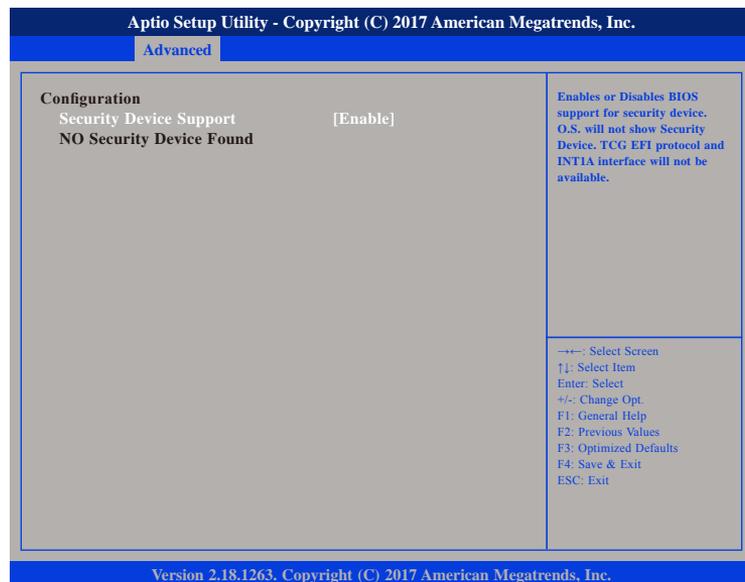


Network Stack

Enables or disables UEFI network stack.

Trusted Computing

This section is used to configure Trusted Platform Module (TPM) settings.



Security Device Support

Enables or disables BIOS support for security device. O.S will not show Security Device. TCG EFI protocol and INT1A interface will not be available.

USB Configuration

This section is used to configure the USB.



Legacy USB Support

Enable Enables Legacy USB.

Auto Disables support for Legacy when no USB devices are connected.

Disable Keeps USB devices available only for EFI applications.

XHCI Hand-off

This is a workaround for OSs that does not support XHCI hand-off. The XHCI ownership change should be claimed by the XHCI driver.

USB Mass Storage Driver Support

Enables or disables USB mass storage driver support.

USB Transfer Time-out

The time-out value for control, bulk, and Interrupt transfers.

Device Reset Time-out

Selects the USB mass storage device's start unit command timeout.

Device Power-up Delay

Maximum time the value will take before it properly reports itself to the Host Controller. "Auto" uses default value: for a Root port it is 100 ms, for a Hub port the delay is taken from Hub descriptor.

Chipset

This section is used to configure the system based on the specific features of the chipset.



Setting incorrect field values may cause the system to malfunction.

South Bridge



SMBus Support

Enables or disables SMBus support.

South Cluster Configuration



HD-Audio Configuration



HD-Audio Support

Enables or disables HD Audio support.

SATA Drives



Chipset SATA

Enables or disables the SATA controller chipset. The SATA controller chipset supports the 2 black internal SATA ports (up to 3Gb/s supported per port).

Port 0

Enables or disables SATA port 0.

Port 1

Enables or disables SATA port 1.

USB Configuration



xHCI Mode

Enables or disables XHCI mode. Once disabled, XHCI controller function will be disabled and all the USB devices will not be detectable and usable during boot up and in OS. Please do not disable it unless for debugging purposes.

Boot



Bootup NumLock State

This allows you to determine the default state of the numeric keypad. By default, the system boots up with NumLock on wherein the function of the numeric keypad is the number keys. When set to Off, the function of the numeric keypad is the arrow keys

Quiet Boot

Enabled Displays OEM logo instead of the POST messages.
 Disabled Displays normal POST messages.

Boot Option Priorities

Adjust the boot sequence of the system. Boot Option #1 is the first boot device that the system will boot from, next will be #2 and so forth.

Fast Boot

Enables or disables boot with initialization of a minimal set of devices required to launch active boot option. Has no effect for BBS boot options.

Save & Exit



Save Changes and Reset

To save the changes and reset, select this field then press <Enter>. A dialog box will appear. Confirm by selecting Yes.

Discard Changes and Reset

To exit the Setup utility and reboot the system without saving the changes, select this field then press <Enter>. You may be prompted to confirm again before exiting.

Restore Defaults

To restore the BIOS to default settings, select this field then press <Enter>. A dialog box will appear. Confirm by selecting Yes.